

LEAKAGE CURRENT REDUCTION METHOD

5 FIELD OF THE INVENTION

The present invention relates to electronic circuitry and, in particular, to a leakage current reduction method.

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BACKGROUND OF THE INVENTION

In a prior approach for powering down a circuit system, when the system goes into sleep / data retention mode, the main power supply VDD goes from 1.3V (in active mode) to near 0V, a retaining power supply VRET remains unchanged at, for example, 1.3V, a retain signal RET goes from 0V to VRET (1.3V) level, and some internal nodes of the system are raised to a reference voltage VBB level (for example 0.6V).

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For circuits whose data needs to be retained when the system goes into sleep / data retention mode, the typical way of turning off the P Channel (PCH) device is shown below:

25 Vdrain = VBB (0V --> 0.6V, for example)
Vgate = RET (0 --> 1.3V, for example)
Vsource = VDD (1.3V --> 0V, for example)
Vbulk = VRET (1.3V , for example)

This is demonstrated in the wordline circuit shown in Figure 1. This circuit has a P channel device 20 as a header. The circuit also includes P channel device 22, N channel device 24, and N channel device 26. When this circuit goes into sleep / data retention mode, source voltage V_{source} goes from the active level power supply level V_{DD} (for example 1.3V) to 0V; the drain voltage V_{drain} goes to the reference voltage V_{BB} (for example 0.6V); the gate voltage V_{gate} goes to the retain signal RET , which goes from 0V to retaining power supply V_{RET} (1.3V, for example); and the back gate V_{bulk} goes to the retaining power supply V_{RET} .

The problem with this prior art solution is that large voltage differences between the gate (1.3V) and the source (0V) / drain (0.6V) exist which results in large gate tunneling leakage, which dominates the P channel device leakage at room temperature since the sub-threshold leakage is suppressed by the deep back-gate bias. This leads to high standby power consumption.

SUMMARY OF THE INVENTION

A method for powering down a circuit for a data retention mode includes: changing a supply voltage node from an active power voltage level to an inactive power level; coupling a source

of a P channel device to the supply voltage node; providing a retaining power supply voltage level to a back gate of the P channel device; changing a drain voltage of the P channel device to a reference voltage level, wherein the reference voltage level is different from the retaining power supply voltage level; and changing a gate voltage of the P channel device to the reference voltage level.

10 BRIEF DESCRIPTION OF THE DRAWINGS

In the drawings:

The Drawing is a diagram of a wordline circuit with a P channel device as header.

DETAILED DESCRIPTION OF PREFERRED EMBODIMENTS

The preferred embodiment solution to this problem is to raise the gate of the P channel device 20 to reference voltage VBB (0.6V, for example), instead of retain signal RET (1.3V, for example) when the system goes into sleep / data retention mode, as shown below:

Vdrain = VBB (0V --> 0.6V)
10 Vgate = VBB (0 --> 0.6V)
Vsource = VDD (1.3V --> 0V)
Vbulk = VRET (1.3V)

Since the voltage differences between the gate (0.6V) and
15 the source (0V) / drain (0.6V) are greatly reduced, the gate tunneling leakage and standby power consumption are also greatly reduced. In fact, the leakage from the reference voltage node VBB does not contribute to any power consumption, since it is provided by the leakage from other parts of the system such as
20 retention SRAM arrays.

A similar method can be applied to turn off the N channel device if e.g. the source is raised from 0V to 1.3V (retaining voltage), drain is raised from 0V to 0.6V (reference voltage VBB), and bulk remains at 0V when the system goes into sleep /
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data retention mode. In such a case, the gate can be raised to reference voltage VBB instead of kept at 0V.

One advantage of the preferred embodiment circuit is that it
5 saves large gate leakage that helps meet leakage budget requirements when the circuit is in power down mode. Another advantage is that the leakage from the reference voltage source VBB does not contribute to any power consumption, since it is provided by the leakage from other parts of the system such as
10 retention SRAM arrays.

While this invention has been described with reference to an illustrative embodiment, this description is not intended to be
15 construed in a limiting sense. Various modifications and combinations of the illustrative embodiment, as well as other embodiments of the invention, will be apparent to persons skilled in the art upon reference to the description. It is therefore intended that the appended claims encompass any such modifications
20 or embodiments.